L Number	Hits	Search Text	DB	Time stamp
1	20031	ptc or ntc or positive adj temperature	HCDAM -	2004/06/08
1 *	20031	adj coefficient or negative adj	USPAT;	2004/06/23
		temperature adj coefficient	US-PGPUB;	13:52
		competatate and contrictent	EPO; JPO; IBM TDB	
2	1327	thermally adj conductive adj adhesive	USPAT;	2004/06/23
	1327	autesive	US-PGPUB;	13:52
			EPO; JPO;	13.32
			IBM TDB	
3	0	((thermally adj conductive adj adhesive))	USPAT;	2004/06/23
		with eloectrode	US-PGPUB;	13:52
			EPO; JPO;	
İ	-		IBM TDB	
4	0	(thermally adj conductive adj adhesive)	USPAT;	2004/06/23
		with eloectrode	US-PGPUB;	13:53
			EPO; JPO;	
			IBM TDB	
5	18	(thermally adj conductive adj adhesive)	USPAT;	2004/06/23
		with electrode	US-PGPUB;	13:53
1			EPO; JPO;	
			IBM_TDB	'
6	54444	silicon adj carbide	USPAT;	2004/06/23
			US-PGPUB;	13:54
			EPO; JPO;	
		//*	IBM_TDB	
7	4		USPAT;	2004/06/23
		with electrode) and (silicon adj carbide)	US-PGPUB;	14:00
			EPO; JPO;	
8	454	silicon with adhesive and military and	IBM_TDB	2004/06/22
	454	silicon with adhesive and silicon adj carbide with adhesive	USPAT;	2004/06/23
		Carpide Afth addeding	US-PGPUB;	14:01
			EPO; JPO; IBM TDB	,
9	1	(ptc or ntc or positive adj temperature	USPAT;	2004/06/23
	1	adj coefficient or negative adj	US-PGPUB;	14:02
]		temperature adj coefficient) and	EPO; JPO;	1
		(((thermally adj conductive adj adhesive)	IBM TDB	
		with electrode) and (silicon adj		
		carbide)) and (silicon with adhesive and		
1		silicon adj carbide with adhesive)		
12	1	(ptc or ntc or positive adj temperature	USPAT;	2004/06/23
		adj coefficient or negative adj	US-PGPUB;	14:03
		temperature adj coefficient) and	EPO; JPO;	
		(((thermally adj conductive adj adhesive)	IBM_TDB	
j		with electrode) and (silicon adj		
12	,	carbide))	110220	0004/05/05
13	1	(((thermally adj conductive adj adhesive)	USPAT;	2004/06/23
		with electrode) and (silicon adj	US-PGPUB;	14:03
		carbide)) and (silicon with adhesive and silicon adj carbide with adhesive)	EPO; JPO;	
10	8	(ptc or ntc or positive adj temperature	IBM_TDB USPAT;	2004/06/22
10	٥	adj coefficient or negative adj	US-PGPUB;	2004/06/23
		temperature adj coefficient) and (silicon	EPO; JPO;	14:12
		with adhesive and silicon adj carbide	IBM TDB	
		with adhesive)	TDE _ TDB	
14	19596	(heater or heating adj element) with	USPAT;	2004/06/23
		(electrode next adhesive)	US-PGPUB;	14:13
		· · · · · · · · · · · · · · · · · · ·	EPO; JPO;	
			IBM TDB	
15	16	((heater or heating adj element) with	USPAT;	2004/06/23
		(electrode next adhesive)) and (silicon	US-PGPUB;	14:13
		with adhesive and silicon adj carbide	EPO; JPO;	
	*	with adhesive)	IBM TDB	